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PATENT AND TRADEM.

12/04/01

Inventor(s):
Krishnaswamy Ramkumar
Steven S. Hedayati

Title: METHOD OF FORMING
SEMICONDUCTOR STRUCTURES
WITH REDUCED STEP HEIGHTS



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(For new non-provisional applications under 37 CFR § 1.53(b))

[illegible]

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Total Claims	30	-20 =	10	x \$18.00 =	\$180.00
Independent Claims	3	-3 =	0	x \$84.00 =	\$0.00
Multiple Dependent Claims				Fee:	
Basic Fee:					\$ 740.00
Total:					\$ 920.00

2. Request & Certification under 35 U.S.C. 122(b)(2)(B)(i).
3. Patent application which includes: 20 pg. disclosure; 5 pg. claims (1-30); 1 pg. abstract.
4. Informal drawings of Figs. 1 - 6 on 3 sheets.
5. Newly executed Declaration/Power of Attorney.
6. Newly executed Assignment w/cover sheet.
7. Return receipt postcard.

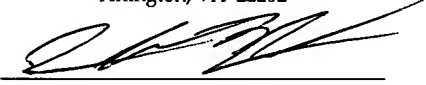
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Respectfully submitted,

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Austin, TX 78767-0398
Date: December 4, 2001

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		Atty Docket Number:	5298-06500
		First Named Inventor:	Krishnaswamy Ramkumar et al.
		Title:	METHOD OF FORMING SEMICONDUCTOR STRUCTURES WITH REDUCED STEP HEIGHTS

I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

December 4, 2001

Date


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This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**

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